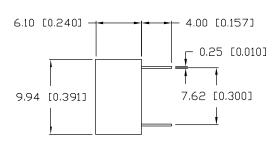
UNCONTROLLED DOCUMENT

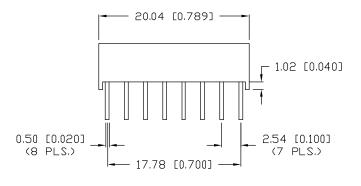
PART NUMBER

REV.

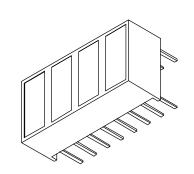
SSB-LX2820GW

3.81 [0.150] 1.27 [0.050] (3 PLS.) (4 PLS.) 16 15 14 13 12 11 10 9 8.89 [0.350]





1 2 3 4 5 6 7 8



2 	3 \ \ \ \	6 + +	7 \ \ \ \	10 \ \ \ \ \	11 \ \ \ \ \	14	15 \ \ \ \ \	

1 4 5 8 9 12 13 16

ELECTRO-OPTICAL CHARACTERISTICS TA=25°C If=20mA						
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND	
PEAK WAVELENGTH		565		nm		
FORWARD VOLTAGE		2.2	2.6	۷f		
REVERSE VOLTAGE	5.0			v_r	1 _r =100,uA	
AXIAL INTENSITY		25		mcd	$I_f = 20mA$	
VIEWING ANGLE		160		2x theta		
EMITTED COLOR:	GREEN					
EPOXY LENS FINISH: MILKY WHITE DIFFUSED						

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mΑ
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	•C
SOLDERING TEMP.	+ 260	°C
2.0mm FROM BODY		3 SEC. MAX
4 1 44 0 0		

* t<10µS

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*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.003), MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), MIN= +DECIMAL PRECISION ARE: X=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD SIZE=±0.05 (±0.002), MIN= +DECIMAL PRECISION ARE: X=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), MIN= +DECIMAL PRECISION ARE: X=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.005). LEAD SIZE=±0.05

REV.

PART NUMBER SSB-LX2820GW

10mm x 20mm, 4 WINDOW, 8 CHIP LIGHT BAR. GREEN CHIPS, MILKY WHITE DIFFUSED.

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RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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CHECKED BY: APPROVED BY: DATE: 1.17.03 PAGE: 1 OF 1 SCALE: N/A